Tiny Real-Time Clock/calendar with alarm function and SPI-bus

Rev. 6 — 18 November 2015

**Product data sheet** 

## 1. General description

The PCF85063BTL is a CMOS<sup>1</sup> Real-Time Clock (RTC) and calendar optimized for low power consumption. An offset register allows fine-tuning of the clock. All addresses and data are transferred serially via a Serial Peripheral Interface (SPI-bus) with a maximum data rate of 7 Mbit/s. The register address is incremented automatically after each written or read data byte.

For a selection of NXP Real-Time Clocks, see <u>Table 46 on page 49</u>.

## 2. Features and benefits

- Provides year, month, day, weekday, hours, minutes, and seconds based on a 32.768 kHz quartz crystal
- Clock operating voltage: 0.9 V to 5.5 V
- Low current; typical 0.22 μA at V<sub>DD</sub> = 3.3 V and T<sub>amb</sub> = 25 °C
- 3 line SPI-bus with a maximum data rate of 7 Mbit/s
- Programmable clock output for peripheral devices (32.768 kHz, 16.384 kHz, 8.192 kHz, 4.096 kHz, 2.048 kHz, 1.024 kHz, and 1 Hz)
- Selectable integrated oscillator load capacitors for C<sub>L</sub> = 7 pF or C<sub>L</sub> = 12.5 pF
- Alarm function
- Countdown timer
- Minute and half minute interrupt
- Oscillator stop detection function
- Internal Power-On Reset (POR)
- Programmable offset register for frequency adjustment

# 3. Applications

- Digital still camera
- Digital video camera
- Printers
- Copy machines
- Mobile equipment
- Battery powered devices

<sup>1.</sup> The definition of the abbreviations and acronyms used in this data sheet can be found in Section 21.



## 4. Ordering information

# Table 1. Ordering information Type number Package Name Description Version PCF85063BTL DFN2626-10 plastic thermal enhanced extremely thin small outline package; no leads; 10 terminals; body 2.6 × 2.6 × 0.5 mm SOT1197-1

## 4.1 Ordering options

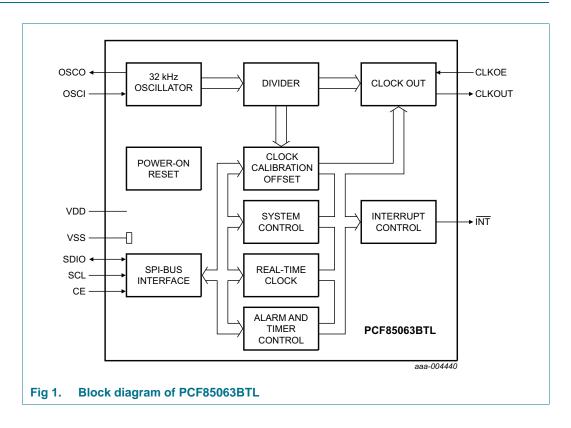
#### Table 2. Ordering options

Product type number	Orderable part number	Sales item (12NC)		IC revision
PCF85063BTL/1	PCF85063BTL/1,118	935299023118	tape and reel, 7 inch	1

## 5. Marking

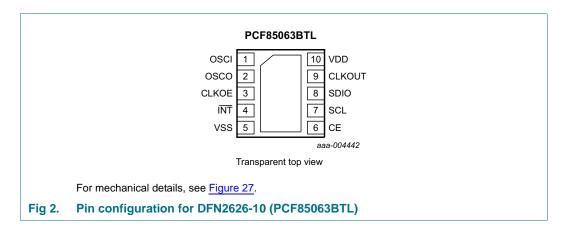
Table 3.   Marking codes	3. Marking codes					
Product type number	Marking code					
PCF85063BTL	063B					

## 6. Block diagram



## 7. Pinning information

## 7.1 Pinning



## 7.2 Pin description

#### Table 4. Pin description

Input or input/output pins must always be at a defined level (V<sub>SS</sub> or V<sub>DD</sub>) unless otherwise specified.

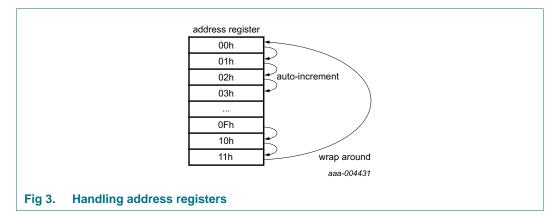
Symbol	Pin	Туре	Description
OSCI	1	input	oscillator input
OSCO	2	output	oscillator output
CLKOE	3	input	CLKOUT enable or disable pin; enable is active HIGH
INT	4	output	interrupt output (open-drain)
VSS	5 <u>[1]</u>	supply	ground supply voltage
CE	6	input	chip enable
SCL	7	input	serial clock input
SDIO	8	input/output	serial data input and output
CLKOUT	9	output	clock output (push-pull)
VDD	10	supply	supply voltage

[1] The die paddle (exposed pad) is connected to V<sub>SS</sub> through high ohmic (non-conductive) silicon attach and should be electrically isolated. It is good engineering practice to solder the exposed pad to an electrically isolated PCB copper pad as shown in <u>Figure 27 "Package outline SOT1197-1 (DFN2626-10) of PCF85063BTL"</u> for better heat transfer but it is not required as the RTC doesn't consume much power. In no case should traces be run under the package exposed pad.

#### 8. **Functional description**

The PCF85063BTL contains 18 8-bit registers with an auto-incrementing register address, an on-chip 32.768 kHz oscillator with integrated capacitors, a frequency divider which provides the source clock for the Real-Time Clock (RTC) and calender, and SPI-bus with a maximum data rate of 6.25 Mbit/s.

The built-in address register will increment automatically after each read or write of a data byte up to the register 11h. After register 11h, the auto-incrementing will wrap around to address 00h (see Figure 3).



All registers (see Table 5) are designed as addressable 8-bit parallel registers although not all bits are implemented. The first two registers (memory address 00h and 01h) are used as control and status register. The register at address 02h is an offset register allowing the fine-tuning of the clock; and at 03h is a free RAM byte. The addresses 04h through 0Ah are used as counters for the clock function (seconds up to years counters). Address locations 0Bh through 0Fh contain alarm registers which define the conditions for an alarm. The registers at 10h and 11h are for the timer function.

The Seconds, Minutes, Hours, Days, Months, and Years as well as the corresponding alarm registers are all coded in Binary Coded Decimal (BCD) format. When one of the RTC registers is written or read, the contents of all time counters are frozen. Therefore, faulty writing or reading of the clock and calendar during a carry condition is prevented.

## 8.1 Registers organization

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 Table 5.
 Registers overview

 Bit positions labeled as - are not implemented. After reset, all registers are set according to Table 8 on page 10.

Address	Register name	Bit	Bit							
		7	6	5	4	3	2	1	0	
Control a	nd status registers	5								
00h	Control_1	EXT_TEST	-	STOP	SR	-	CIE	12_24	CAP_SEL	Section 8.2.
01h	Control_2	AIE	AF	MI	HMI	TF	COF[2:	0]	I	Section 8.2.
02h	Offset	MODE	OFFSET[6:	DFFSET[6:0]						Section 8.2.
03h	RAM_byte	B[7:0]								Section 8.2.
Time and	date registers									
04h	Seconds	econds OS SECONDS (0 to 59)							Section 8.3.	
05h	Minutes	-	MINUTES (	NUTES (0 to 59)					Section 8.3.	
06h	Hours	-	-	AMPM	HOURS (1	to 12) in 12	2 hour mode			Section 8.3.
				HOURS (0 to 23) in 24 hour mode						
07h	Days	-	-	- DAYS (1 to 31)						Section 8.3.
08h	Weekdays	-	-	-	WEEKDAYS (0 to 6)				Section 8.3.	
09h	Months	-	-	- MONTHS (1 to 12)				Section 8.3.		
0Ah	Years	YEARS (0 to	99)							Section 8.3.
Alarm reg	isters									
0Bh	Second_alarm	AEN_S	SECOND_A	ALARM (0 to 5	9)					Section 8.5.
0Ch	Minute_alarm	AEN_M	MINUTE_A	LARM (0 to 59)	)					Section 8.5.
0Dh	Hour_alarm	AEN_H	-	AMPM	HOUR_AL	ARM (1 to 2	2) in 12 hour	mode		Section 8.5.
				HOUR_ALA	RM (0 to 23)	in 24 hour i	node			
0Eh	Day_alarm	AEN_D	-	DAY_ALAR	M (1 to 31)					Section 8.5.
0Fh	Weekday_alarm	AEN_W	-	-	-	-	WEEKI	DAY_ALARM (0 t	o 6)	Section 8.5.
Timer reg	-	1				1		X	-	
10h	Timer_value	T[7:0]								Section 8.6.
11h	Timer_mode	-	-	-	TCF[1:0]		TE	TIE	TI_TP	Section 8.6.

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## 8.2 Control registers

# 8.2.1 Register Control\_1

Table 6.	Control_1 - control and s	tatus register 1 (address	s 00h) bit description
----------	---------------------------	---------------------------	------------------------

Bit	Symbol	Value	Description	Reference
7	EXT_TEST		external clock test mode	Section 8.2.1.1
		0[1]	normal mode	
		1	external clock test mode	
6	-	0	unused	-
5	STOP		STOP bit	Section 8.2.1.2
		0[1]	RTC clock runs	
		1	RTC clock is stopped; all RTC divider chain flip-flops are asynchronously set logic 0	
4	SR		software reset	Section 8.2.1.3
		0[1]	no software reset	
	1	initiate software reset <sup>[2]</sup> ; this bit always returns a 0 when read		
3	-	0	unused	-
2	CIE		correction interrupt enable	Section 8.2.3
		0[1]	no correction interrupt generated	
		1	interrupt pulses are generated at every correction cycle	
1	12_24		12 or 24 hour mode	Section 8.3.3
		0[1]	24 hour mode is selected	Section 8.5.3
		1	12 hour mode is selected	
0	CAP_SEL		<b>internal oscillator capacitor selection</b> for quartz crystals with a corresponding load capacitance	-
		0[1]	7 pF	
		1	12.5 pF	

[1] Default value.

[2] For a software reset, 01011000 (58h) must be sent to register Control\_1 (see Section 8.2.1.3).

#### Tiny Real-Time Clock/calendar with alarm function and SPI-bus

#### 8.2.1.1 EXT TEST: external clock test mode

A test mode is available which allows for on-board testing. In this mode, it is possible to set up test conditions and control the operation of the RTC.

The test mode is entered by setting bit EXT TEST in register Control 1. Then pin CLKOUT becomes an input. The test mode replaces the internal clock signal with the signal applied to pin CLKOUT.

The signal applied to pin CLKOUT should have a minimum pulse width of 300 ns and a maximum period of 1000 ns. The internal clock, now sourced from CLKOUT, is divided down to 1 Hz by a 2<sup>6</sup> divide chain called a prescaler. The prescaler can be set into a known state by using bit STOP. When bit STOP is set, the prescaler is reset to 0. (STOP must be cleared before the prescaler can operate again.)

From a stop condition, the first 1 second increment will take place after 32 positive edges on pin CLKOUT. Thereafter, every 64 positive edges cause a 1 second increment.

**Remark:** Entry into test mode is not synchronized to the internal 64 Hz clock. When entering the test mode, no assumption as to the state of the prescaler can be made.

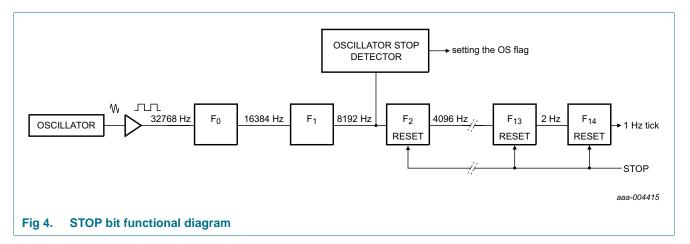
Operation example:

- 1. Set EXT\_TEST test mode (register Control 1, bit EXT\_TEST = 1).
- 2. Set STOP (register Control\_1, bit STOP = 1).
- 3. Clear STOP (register Control 1, bit STOP = 0).
- 4. Set time registers to desired value.
- 5. Apply 32 clock pulses to pin CLKOUT.
- 6. Read time registers to see the first change.
- 7. Apply 64 clock pulses to pin CLKOUT.
- 8. Read time registers to see the second change.

Repeat 7 and 8 for additional increments.

#### 8.2.1.2 STOP: STOP bit function

The function of the STOP bit (see Figure 4) is to allow for accurate starting of the time circuits. The STOP bit function causes the upper part of the prescaler ( $F_2$  to  $F_{14}$ ) to be held in reset and thus no 1 Hz ticks are generated. It also stops the output of clock frequencies lower than 8 kHz on pin CLKOUT.



The time circuits can then be set and do not increment until the STOP bit is released (see Figure 5 and Table 7).

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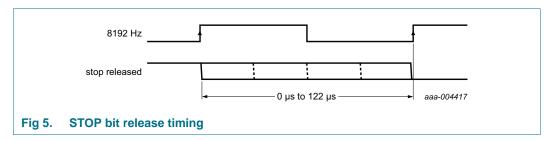
#### Tiny Real-Time Clock/calendar with alarm function and SPI-bus

Prescaler bits <sup>[1]</sup>		7. First increment of time circuits after STOP bit release					
	1 Hz tick	Time	Comment				
F <sub>0</sub> F <sub>1</sub> -F <sub>2</sub> to F <sub>14</sub>		hh:mm:ss					
running normally							
01-0 0001 1101 0100		12:45:12	prescaler counting normally				
is activated by user.	F <sub>0</sub> F <sub>1</sub> are not rese	t and values ca	annot be predicted externally				
XX-0 0000 0000 0000		12:45:12	prescaler is reset; time circuits are frozen				
is set by user	1						
XX-0 0000 0000 0000		08:00:00	prescaler is reset; time circuits are frozen				
is released by user							
XX-0 0000 0000 0000		08:00:00	prescaler is now running				
XX-1 0000 0000 0000	0.507813 to 0.507935 s	08:00:00	-				
XX-0 1000 0000 0000		08:00:00	-				
XX-1 1000 0000 0000		08:00:00	-				
:		:	:				
11-1 1111 1111 1110		08:00:00	-				
00-0 0000 0000 0001		08:00:01	0 to 1 transition of F <sub>14</sub> increments the time circuits				
10-0 0000 0000 0001		08:00:01	-				
:	<b>1 1</b>	:	:				
11-1 1111 1111 1111	1.000000 s	08:00:01	-				
00-0 0000 0000 0000		08:00:01	-				
10-0 0000 0000 0000		08:00:01	-				
:		:	:				
11-1 1111 1111 1110	1 1	08:00:01	-				
00-0 0000 0000 0001	│ <u>`</u> <b>` ` ` ` ` ` ` ` ` `</b>	08:00:02	0 to 1 transition of F <sub>14</sub> increments the time circuits				
	aaa-004416						
;	unning normally           01-0         0001         1101         0100           is activated by user.           XX-0         0000         0000         0000           is set by user           XX-0         0000         0000         0000           is released by user           XX-0         0000         0000         0000           is released by user           XX-0         1000         0000         0000           XX-0         1000         0000         0000           XX-0         1000         0000         0000           XX-0         1000         0000         0000           XX-1         1000         0000         0001           10-0         0000         0000         0001           10-0         0000         0000         0000           10-0         0000         0000         0000           10-0         00000	unning normally         01-0       0001       1101       0100         is activated by user.       F <sub>0</sub> F <sub>1</sub> are not reserved         XX-0       0000       0000       0000         is set by user       XX-0       0000       0000         is released by user       XX-0       0000       0000         XX-0       0000       0000       0000         xx-1       0000       0000       0000         XX-1       1000       0000       0000         XX-1       1000       0000       0001         ix       11-1       1111       1110         00-0       0000       0000       0001         i       11-1       1111       1111         00-0       0000       0000       1000         i       11-1       1111       1111         00-0       0000       0000       1000         i       11-1       1111       1111         00-0       0000       0000       1000         i       11-1       1111       1110         00-0       0000       0000       1         i       11-1       1111       1110	unning normally $01-0 \ 0001 \ 1101 \ 0100$ 12:45:12         is activated by user. $F_0F_1$ are not reset and values can value values. $xx-0 \ 0000 \ 0000 \ 0000$ 08:00:00         is set by user $xx-0 \ 0000 \ 0000 \ 0000$ 08:00:00         is released by user $xx-0 \ 0000 \ 0000 \ 0000$ 08:00:00 $xx-1 \ 0000 \ 0000 \ 0000$ 08:00:00 $xx-1 \ 1000 \ 0000 \ 0000$ 08:00:01 $0.507935 \ s$ 08:00:01 $11-1 \ 1111 \ 1111 \ 1111$ 08:00:01 $10-0 \ 0000 \ 0000 \ 0000$ 08:00:01 $10-0 \ 0000 \ 0000 \ 0000$ 08:00:01 $11-1 \ 1111 \ 1111 \ 1111$ 08:00:01 $08:00:01$ 08:00:01 $08:00:01$ 08:00:01 $00-0 \ 0000 \ 0000 \ 0000$ 0001				

#### Table 7. First increment of time circuits after STOP bit release

[1]  $F_0$  is clocked at 32.768 kHz.

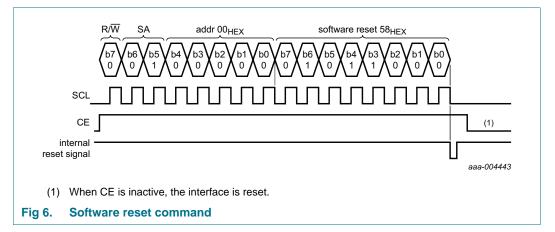
The lower two stages of the prescaler ( $F_0$  and  $F_1$ ) are not reset. And because the SPI-bus is asynchronous to the crystal oscillator, the accuracy of restarting the time circuits is between zero and one 8.192 kHz cycle (see Figure 5).



The first increment of the time circuits is between 0.507813 s and 0.507935 s after STOP bit is released. The uncertainty is caused by the prescaler bits  $F_0$  and  $F_1$  not being reset (see Table 7) and the unknown state of the 32 kHz clock.

#### 8.2.1.3 Software reset

A reset is automatically generated at power-on. A reset can also be initiated with the software reset command. Software reset command means setting bits 6, 4, and 3 in register Control\_1 (00h) logic 1 and all other bits logic 0 by sending the bit sequence 01011000 (58h), see Figure 6.



In reset state all registers are set according to <u>Table 8</u> and the address pointer returns to address 00h.

Address	Register name	Bit	Bit							
		7	6	5	4	3	2	1	0	
00h	Control_1	0	0	0	0	0	0	0	0	
01h	Control_2	0	0	0	0	0	0	0	0	
02h	Offset	0	0	0	0	0	0	0	0	
03h	RAM_byte	0	0	0	0	0	0	0	0	
04h	Seconds	1	0	0	0	0	0	0	0	
05h	Minutes	0	0	0	0	0	0	0	0	
06h	Hours	0	0	0	0	0	0	0	0	
07h	Days	0	0	0	0	0	0	0	1	
08h	Weekdays	0	0	0	0	0	1	1	0	
09h	Months	0	0	0	0	0	0	0	1	
0Ah	Years	0	0	0	0	0	0	0	0	
0Bh	Second_alarm	1	0	0	0	0	0	0	0	
0Ch	Minute_alarm	1	0	0	0	0	0	0	0	
0Dh	Hour_alarm	1	0	0	0	0	0	0	0	
0Eh	Day_alarm	1	0	0	0	0	0	0	0	
0Fh	Weekday_alarm	1	0	0	0	0	0	0	0	
10h	Timer_value	0	0	0	0	0	0	0	0	
11h	Timer_mode	0	0	0	1	1	0	0	0	

#### Table 8. Registers reset values

#### Tiny Real-Time Clock/calendar with alarm function and SPI-bus

The PCF85063BTL resets to:

Time — 00:00:00 Date — 20000101 Weekday — Saturday

#### 8.2.2 Register Control\_2

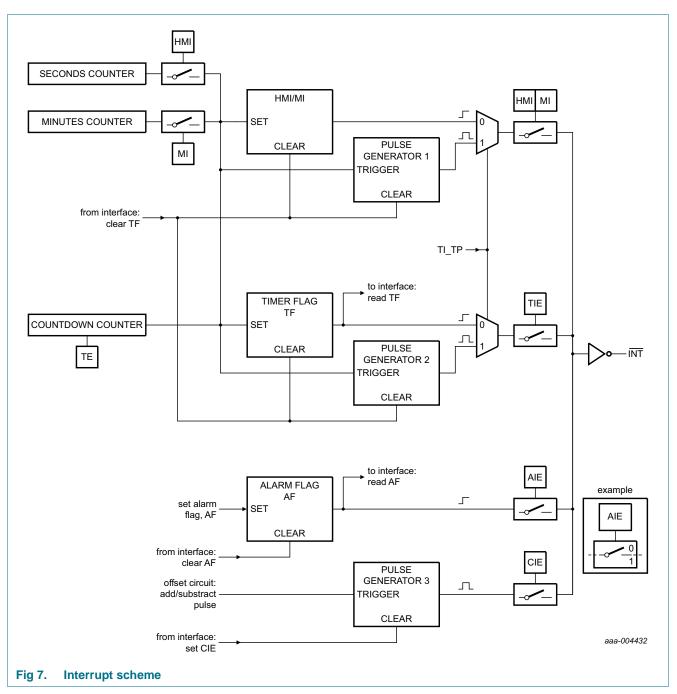
#### Table 9. Control\_2 - control and status register 2 (address 01h) bit description

Bit	Symbol	Value	Description	Reference
7	AIE		alarm interrupt	Section 8.2.2.1
		0[1]	disabled	Section 8.5.6
		1	enabled	
6	AF		alarm flag	Section 8.2.2.1
		0[1]	read: alarm flag inactive	Section 8.5.6
			write: alarm flag is cleared	
		1	read: alarm flag active	
			write: alarm flag remains unchanged	
5	5 MI		minute interrupt	Section 8.2.2.2
		0[1]	disabled	Section 8.2.2.3
		1	enabled	
4	HMI		half minute interrupt	Section 8.2.2.2
		0[1]	disabled	Section 8.2.2.3
		1	enabled	
3	TF		timer flag	Section 8.2.2.1
		0[1]	no timer interrupt generated	Section 8.2.2.3 Section 8.6.3
		1	flag set when timer interrupt generated	
2 to 0	COF[2:0]	see Table 11	CLKOUT control	Section 8.2.2.4

[1] Default value.

Tiny Real-Time Clock/calendar with alarm function and SPI-bus





**AIE:** This bit activates or deactivates the generation of an interrupt when AF is asserted, respectively.

**AF:** When an alarm occurs, AF is set logic 1. This bit maintains its value until overwritten by command. To prevent one flag being overwritten while clearing another, a logic AND is performed during a write access.

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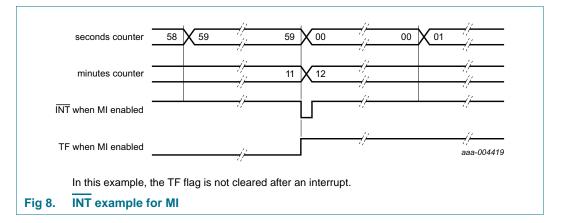
#### 8.2.2.2 MI and HMI: minute and half minute interrupt

The minute interrupt (bit MI) and half minute interrupt (bit HMI) are pre-defined timers for generating interrupt pulses on pin INT; see <u>Figure 8</u>. The timers are running in sync with the seconds counter (see <u>Table 19 on page 19</u>).

The minute and half minute interrupts must only be used when the frequency offset is set to normal mode (MODE = 0), see Section 8.2.3. In normal mode, the interrupt pulses on pin  $\overline{INT}$  are  $\frac{1}{64}$  s wide.

When starting MI, the first interrupt will be generated after 1 second to 59 seconds. When starting HMI, the first interrupt will be generated after 1 second to 29 seconds.

Subsequent periods do not have such a delay. The timers can be enabled independently from one another. However, a minute interrupt enabled on top of a half minute interrupt is not distinguishable.



#### Table 10. Effect of bits MI and HMI on INT generation

Minute interrupt (bit MI)	Half minute interrupt (bit HMI)	Result
0	0	no interrupt generated
1	0	an interrupt every minute
0	1	an interrupt every 30 s
1	1	an interrupt every 30 s

The duration of the timer is affected by the register Offset (see <u>Section 8.2.3</u>). Only when OFFSET[6:0] has the value 00h the periods are consistent.

#### 8.2.2.3 TF: timer flag

The timer flag (bit TF) is set logic 1 on the first trigger of MI, HMI, or the countdown timer. The purpose of the flag is to allow the controlling system to interrogate what caused the interrupt: timer or alarm. The flag can be read and cleared by command.

The status of the timer flag TF can affect the INT pulse generation depending on the setting of TI\_TP (see Section 8.6.2 "Register Timer\_mode" on page 28):

- When TI\_TP is set logic 1
  - an INT pulse is generated independent of the status of the timer flag TF
  - TF stays set until it is cleared
  - TF does not affect INT

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- the countdown timer runs in a repetitive loop and keeps generating timed periods
- When TI\_TP is set logic 0
  - the INT generation follows the TF flag
  - TF stays set until it is cleared
  - If TF is not cleared before the next coming interrupt, no INT is generated
  - the countdown timer stops after the first countdown

#### 8.2.2.4 COF[2:0]: Clock output frequency

A programmable square wave is available at pin CLKOUT. Operation is controlled by the COF[2:0] bits in the register Control\_2. Frequencies of 32.768 kHz (default) down to 1 Hz can be generated for use as a system clock, microcontroller clock, input to a charge pump, or for calibration of the oscillator.

Pin CLKOUT is a push-pull output and enabled at power-on. CLKOUT can be disabled by setting COF[2:0] to 111 or by setting CLKOE LOW. When disabled, the CLKOUT is LOW. If CLKOE is HIGH and COF[2:0]=111 there will be no clock and CLKOUT will be LOW.

The duty cycle of the selected clock is not controlled. However, due to the nature of the clock generation, all are 50 : 50 except the 32.768 kHz frequencies.

The STOP bit function can also affect the CLKOUT signal, depending on the selected frequency. When the STOP bit is set logic 1, the CLKOUT pin generates a continuous LOW for those frequencies that can be stopped. For more details of the STOP bit function, see <u>Section 8.2.1.2</u>.

COF[2:0]	CLKOUT frequency (Hz)	Typical duty cycle <sup>[1]</sup>	Effect of STOP bit
000[2]	32768	60 : 40 to 40 : 60	no effect
001	16384	50 : 50	no effect
010	8192	50 : 50	no effect
011	4096	50 : 50	CLKOUT = LOW
100	2048	50 : 50	CLKOUT = LOW
101	1024	50 : 50	CLKOUT = LOW
110	1 <u>3</u>	50 : 50	CLKOUT = LOW
111	CLKOUT = LOW	-	-

#### Table 11. CLKOUT frequency selection

[1] Duty cycle definition: % HIGH-level time : % LOW-level time.

[2] Default values. The duty cycle of the CLKOUT when outputting 32,768 Hz could change from 60:40 to 40:60 depending on the detector since the 32,768 Hz is derived from the oscillator output which is not perfect. It could change from device to device and it depends on the silicon diffusion. There is nothing that can be done from outside the chip to influence the duty cycle.

[3] 1 Hz clock pulses are affected by offset correction pulses.

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#### 8.2.3 Register Offset

The PCF85063BTL incorporates an offset register (address 02h) which can be used to implement several functions, such as:

- Accuracy tuning
- Aging adjustment
- Temperature compensation

Bit	Symbol	Value	Description
7	MODE		offset mode
		0[1]	normal mode: offset is made once every two hours
		1	course mode: offset is made every 4 minutes
6 to 0	OFFSET[6:0]	see Table 13	offset value

Table 12. Offset - offset register (address 02h) bit description

[1] Default value.

For MODE = 0, each LSB introduces an offset of 4.34 ppm. For MODE = 1, each LSB introduces an offset of 4.069 ppm. The values of 4.34 ppm and 4.069 ppm are based on a nominal 32.768 kHz clock. The offset value is coded in two's complement giving a range of +63 LSB to -64 LSB.

#### Table 13. Offset values

OFFSET[6:0]	Offset value in decimal	Offset value in ppr	Offset value in ppm			
		Normal mode MODE = 0	Fast mode MODE = 1			
0111111	+63	+273.420	+256.347			
0111110	+62	+269.080	+252.278			
:	:	:	:			
0000010	+2	+8.680	+8.138			
0000001	+1	+4.340	+4.069			
0000000[1]	0	0[1]	0 <u>[1]</u>			
1111111	-1	-4.340	-4.069			
1111110	-2	-8.680	-8.138			
:	:	:	:			
1000001	-63	-273.420	-256.347			
1000000	-64	-277.760	-260.416			

[1] Default value.

The correction is made by adding or subtracting clock correction pulses, thereby changing the period of a single second but not by changing the oscillator frequency.

It is possible to monitor when correction pulses are applied. To enable correction interrupt generation, bit CIE (register Control\_1) has to be set logic 1. At every correction cycle a pulse is generated on pin INT. The pulse width depends on the correction mode. If multiple correction pulses are applied, an interrupt pulse is generated for each correction pulse applied.

#### 8.2.3.1 Correction when MODE = 0

The correction is triggered once every two hours and then correction pulses are applied once per minute until the programmed correction values have been implemented.

#### Table 14. Correction pulses for MODE = 0

Correction value	Update every n <sup>th</sup> hour	Minute	<u>Cor</u> rection pulses on INT per minute <sup>[1]</sup>	
+1 or –1	2	00	1	
+2 or –2	2	00 and 01	1	
+3 or –3	2	00, 01, and 02	1	
:	:	:	:	
+59 or –59	2	00 to 58	1	
+60 or –60	2	00 to 59	1	
+61 or –61	2	00 to 59	1	
	2nd and next hour	00	1	
+62 or –62	2	00 to 59	1	
	2nd and next hour	00 and 01	1	
+63 or –63	02	00 to 59	1	
	2nd and next hour	00, 01, and 02	1	
-64	02	00 to 59	1	
	2nd and next hour	00, 01, 02, and 03	1	

[1] The correction pulses on pin  $\overline{\text{INT}}$  are  $\frac{1}{64}$  s wide.

In MODE = 0, any timer or clock output using a frequency below 64 Hz is affected by the clock correction (see <u>Table 15</u>).

Frequency (Hz)	Effect of correction
CLKOUT	
32768	no effect
16384	no effect
8192	no effect
4096	no effect
2048	no effect
1024	no effect
1	affected
Timer source clock	
4096	no effect
64	no effect
1	affected
1⁄60	affected

#### 8.2.3.2 Correction when MODE = 1

The correction is triggered once every four minutes and then correction pulses are applied once per second up to a maximum of 60 pulses. When correction values greater than 60 pulses are used, additional correction pulses are made in the 59<sup>th</sup> second.

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Clock correction is made more frequently in MODE = 1; however, this can result in higher power consumption.

Table 16. Correction pulses for MODE = 1

Correction value	Update every n <sup>th</sup> minute	Second	Correction pulses on INT per second <sup>[1]</sup>
+1 or –1	2	00	1
+2 or –2	2	00 and 01	1
+3 or –3	2	00, 01, and 02	1
:	:	:	:
+59 or –59	2	00 to 58	1
+60 or –60	2	00 to 59	1
+61 or –61	2	00 to 58	1
	2	59	2
+62 or –62	2	00 to 58	1
	2	59	3
+63 or –63	2	00 to 58	1
	2	59	4
-64	2	00 to 58	1
	2	59	5

[1] The correction pulses on pin  $\overline{INT}$  are  $\frac{1}{1024}$  s wide. For multiple pulses, they are repeated at an interval of  $\frac{1}{512}$  s.

In MODE = 1, any timer source clock using a frequency below 1.024 kHz is also affected by the clock correction (see <u>Table 17</u>).

Frequency (Hz)	Effect of correction	
CLKOUT		
32768	no effect	
16384	no effect	
8192	no effect	
4096	no effect	
2048	no effect	
1024	no effect	
1	affected	
Timer source clock		
4096	no effect	
64	affected	
1	affected	
1⁄60	affected	

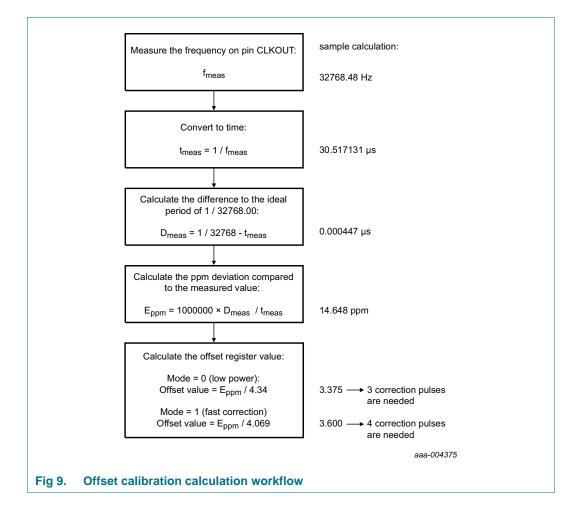
Table 17. Effect of correction pulses on frequencies for MODE = 1

#### 8.2.3.3 Offset calibration workflow

The calibration offset has to be calculated based on the time. Figure 9 shows the workflow how the offset register values can be calculated:

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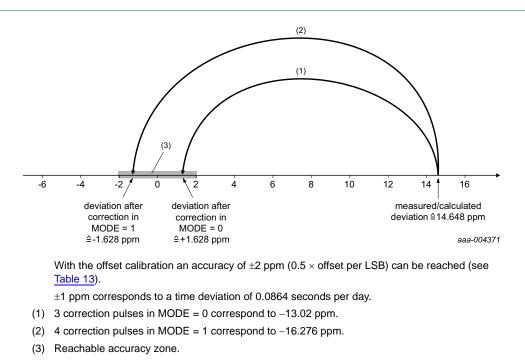


Fig 10. Result of offset calibration

#### 8.2.4 Register RAM\_byte

The PCF85063BTL provides a free RAM byte, which can be used for any purpose, for example, status byte of the system.

#### Table 18. RAM\_byte - 8-bit RAM register (address 03h) bit description

Bit		Symbol	Value	Description
7 to	0 0	B[7:0]	00000000[ <sup>1]</sup> to 11111111	RAM content

[1] Default value.

#### 8.3 Time and date registers

Most of the registers are coded in the BCD format to simplify application use.

#### 8.3.1 Register Seconds

#### Table 19. Seconds - seconds register (address 04h) bit description

Bit	Symbol	Value	Place value	Description	
7 OS				oscillator stop	
		0	-	clock integrity is guaranteed	
		1[1]	-	clock integrity is not guaranteed; oscillator has stopped or has been interrupted	
6 to 4	SECONDS	0 <sup>[1]</sup> to 5	ten's place	actual seconds coded in BCE format, see <u>Table 20</u>	
3 to 0		0 <sup>[1]</sup> to 9	unit place		

[1] Default value.

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Table 20. Seconds coded in BCD format							
Seconds value in	Upper-digit (ten's place)			Digit (u	Digit (unit place)		
decimal	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
00 <u>[1]</u>	0	0	0	0	0	0	0
01	0	0	0	0	0	0	1
02	0	0	0	0	0	1	0
:	:	:	:	:	:	:	:
09	0	0	0	1	0	0	1
10	0	0	1	0	0	0	0
:	:	:	:	:	:	:	:
58	1	0	1	1	0	0	0
59	1	0	1	1	0	0	1

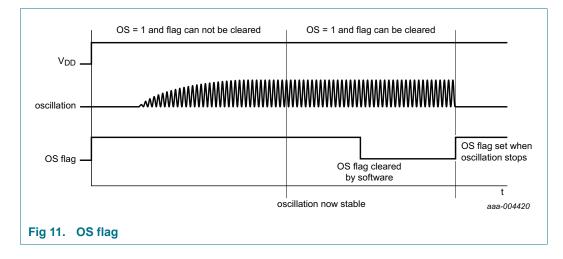
#### Table 20. Seconds coded in BCD format

[1] Default value.

#### 8.3.1.1 OS flag: Oscillator stop

When the oscillator of the PCF85063BTL is stopped, the OS flag is set. The oscillator can be stopped, for example, by connecting one of the oscillator pins OSCI or OSCO to ground. The oscillator is considered to be stopped during the time between power-on and stable crystal resonance. This time can be in the range of 200 ms to 2 s depending on crystal type, temperature, and supply voltage.

The flag remains set until cleared by command (see Figure 11). If the flag cannot be cleared, then the oscillator is not running. This method can be used to monitor the oscillator and to determine if the supply voltage has reduced to the point where oscillation fails.



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#### 8.3.2 Register Minutes

#### Table 21. Minutes - minutes register (address 05h) bit description

Bit	Symbol	Value	Place value	Description
7	-	0	-	unused
6 to 4	MINUTES	0[1] to 5	ten's place	actual minutes coded in BCD
3 to 0		0 <mark>[1]</mark> to 9	unit place	format

[1] Default value.

#### 8.3.3 Register Hours

#### Table 22. Hours - hours register (address 06h) bit description

Bit	Symbol	Value	Place value	Description
7 to 6	-	00	-	unused
12 hour	mode <sup>[1]</sup>			
5	AMPM			AM/PM indicator
		0[2]	-	AM
		1	-	PM
4	HOURS	0 <sup>[2]</sup> to 1	ten's place	actual hours in 12 hour mode
3 to 0	-	0 <sup>[2]</sup> to 9	unit place	coded in BCD format
24 hour	mode <sup>[1]</sup>			
5 to 4	HOURS	0 <sup>[2]</sup> to 2	ten's place	actual hours in 24 hour mode
3 to 0		0 <mark>[2]</mark> to 9	unit place	coded in BCD format

[1] Hour mode is set by the 12\_24 bit in register Control\_1.

[2] Default value.

#### 8.3.4 Register Days

#### Table 23. Days - days register (address 07h) bit description

Bit	Symbol	Value	Place value	Description
7 to 6	-	00	-	unused
5 to 4	DAYS <sup>[1]</sup>	0 <sup>[2]</sup> to 3	ten's place	actual day coded in BCD format
3 to 0	-	0 <mark>[3]</mark> to 9	unit place	

[1] If the year counter contains a value, which is exactly divisible by 4 (including the year 00), the PCF85063BTL compensates for leap years by adding a 29th day to February.

- [2] Default value.
- [3] Default value is 1.

#### 8.3.5 Register Weekdays

#### Table 24. Weekdays - weekdays register (address 08h) bit description

Bit	Symbol	Value	Description
7 to 3	-	00000	unused
2 to 0	WEEKDAYS	0 to 6	actual weekday values, see Table 25

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#### Table 25. Weekday assignments

Day <sup>[1]</sup>	Bit				
	2	1	0		
Sunday	0	0	0		
Monday	0	0	1		
Tuesday	0	1	0		
Wednesday	0	1	1		
Thursday	1	0	0		
Friday	1	0	1		
Saturday <sup>[2]</sup>	1	1	0		

[1] Definition may be reassigned by the user.

[2] Default value.

#### 8.3.6 Register Months

#### Table 26. Months - months register (address 09h) bit description

Bit	Symbol	Value	Place value	Description
7 to 5	-	000	-	unused
4	MONTHS	0 to 1		actual month coded in BCD
3 to 0		0 to 9	unit place	format, see <u>Table 27</u>

#### Table 27. Month assignments in BCD format

Month	Upper-digit (ten's place)	Digit (unit	igit (unit place)				
	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0		
January <sup>[1]</sup>	0	0	0	0	1		
February	0	0	0	1	0		
March	0	0	0	1	1		
April	0	0	1	0	0		
May	0	0	1	0	1		
June	0	0	1	1	0		
July	0	0	1	1	1		
August	0	1	0	0	0		
September	0	1	0	0	1		
October	1	0	0	0	0		
November	1	0	0	0	1		
December	1	0	0	1	0		

[1] Default value.

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#### 8.3.7 Register Years

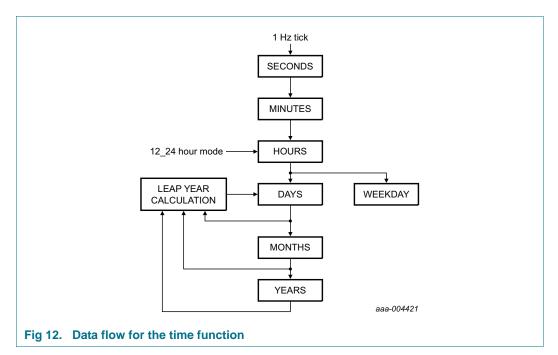
Table 28.	Years - years	s register (0Ah	) bit description
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Bit	Symbol	Value	Place value	Description
7 to 4	YEARS	0 <mark>[1]</mark> to 9	ten's place	actual year coded in BCD format
3 to 0	-	0 <mark>[1]</mark> to 9	unit place	

[1] Default value.

## 8.4 Setting and reading the time

Figure 12 shows the data flow and data dependencies starting from the 1 Hz clock tick.



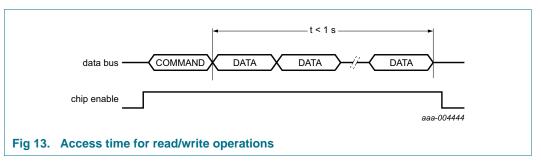
During read/write operations, the time counting circuits (memory locations 04h through 0Ah) are blocked.

The blocking prevents

- Faulty reading of the clock and calendar during a carry condition
- Incrementing the time registers during the read cycle

After this read/write access is completed, the time circuit is released again and any pending request to increment the time counters that occurred during the read/write access is serviced. A maximum of 1 request can be stored; therefore, all accesses must be completed within 1 second (see Figure 13).

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Because of this method, it is very important to make a read or write access in one go, that is, setting or reading seconds through to years should be made in one single access. Failing to comply with this method could result in the time becoming corrupted.

As an example, if the time (seconds through to hours) is set in one access and then in a second access the date is set, it is possible that the time will increment between the two accesses. A similar problem exists when reading. A roll-over may occur between reads thus giving the minutes from one moment and the hours from the next.

Recommended method for reading the time:

- 1. Send read command with register address pointing to 4 (Seconds) by sending 04h
- 2. Read Seconds
- 3. Read Minutes
- 4. Read Hours
- 5. Read Days
- 6. Read Weekdays
- 7. Read Months
- 8. Read Years

#### 8.5 Alarm registers

#### 8.5.1 Register Second\_alarm

#### Table 29. Second\_alarm - second alarm register (address 0Bh) bit description

Bit	Symbol	Value	Place value	Description
7	AEN_S			second alarm
		0	-	enabled
		1 <u>[1]</u>	-	disabled
6 to 4	SECOND_ALARM	0 <u>[1]</u> to 5	ten's place	second alarm information
3 to 0		0 <u>[1]</u> to 9	unit place	coded in BCD format

[1] Default value.

#### 8.5.2 Register Minute\_alarm

#### Table 30. Minute\_alarm - minute alarm register (address 0Ch) bit description

Bit	Symbol	Value	Place value	Description
7	AEN_M			minute alarm
		0	-	enabled
		1 <u>[1]</u>	-	disabled
6 to 4	MINUTE_ALARM	0 <sup>[1]</sup> to 5	ten's place	minute alarm information coded
3 to 0		0 <sup>[1]</sup> to 9	unit place	in BCD format

[1] Default value.

#### 8.5.3 Register Hour\_alarm

#### Table 31. Hour\_alarm - hour alarm register (address 0Dh) bit description

Bit	Symbol	Value	Place value	Description	
7	AEN_H			hour alarm	
		0	-	enabled	
		1[1]	-	disabled	
6	-	0	-	unused	
12 hour mode <sup>[2]</sup>					
5 AMPM			AM/PM indicator		
		0[1]	-	AM	
		1	-	PM	
4	HOUR_ALARM	0 <sup>[1]</sup> to 1	ten's place	hour alarm information in	
3 to 0	-	0 <sup>[1]</sup> to 9	unit place	<b>12 hour mode</b> coded in BCD format	
24 hour	mode <sup>[2]</sup>				
5 to 4	HOUR_ALARM	0 <sup>[1]</sup> to 2	ten's place	hour alarm information in	
3 to 0		0 <u>[1]</u> to 9	unit place	<b>24 hour mode</b> coded in BCD format	

[1] Default value.

[2] Hour mode is set by the 12\_24 bit in register Control\_1.

#### 8.5.4 Register Day\_alarm

#### Table 32. Day\_alarm - day alarm register (address 0Eh) bit description

Bit	Symbol	Value	Place value	Description
7	AEN_D			day alarm
		0	-	enabled
		1[1]	-	disabled
6	-	0	-	unused
5 to 4	DAY_ALARM	0 <sup>[1]</sup> to 3	ten's place	day alarm information coded in
3 to 0		0 <mark>[1]</mark> to 9	unit place	BCD format

[1] Default value.

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	Table 55. Weekuay_alarin - weekuay alarin register (address of it) bit description			
Bit	Symbol	Value	Description	
7	AEN_W		weekday alarm	
		0	enabled	
		1 <u>[1]</u>	disabled	
6 to 3	-	0	unused	
2 to 0	WEEKDAY_ALARM	0 <u>[1]</u> to 6	weekday alarm information coded in BCD format	

#### 8.5.5 Register Weekday alarm

#### Table 33. Weekday alarm - weekday alarm register (address 0Fh) bit description

[1] Default value.

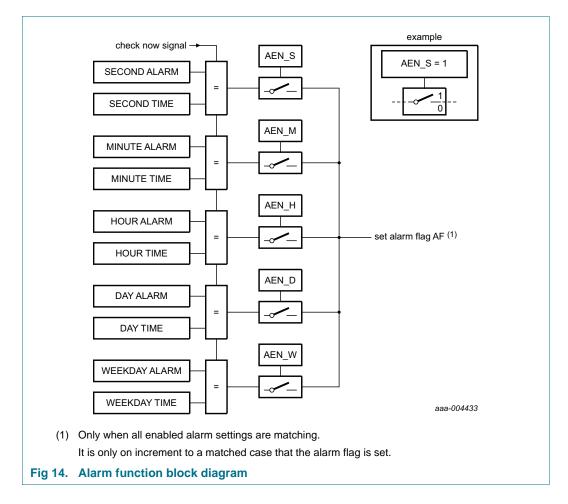
#### 8.5.6 Alarm function

By clearing the alarm enable bit (AEN\_x) of one or more of the alarm registers, the corresponding alarm condition(s) are active. When an alarm occurs, AF is set logic 1. The asserted AF can be used to generate an interrupt (INT). The AF is cleared by command.

The registers at addresses 0Bh through 0Fh contain alarm information. When one or more of these registers is loaded with second, minute, hour, day or weekday, and its corresponding AEN\_x is logic 0, then that information is compared with the current second, minute, hour, day, and weekday. When all enabled comparisons first match, the alarm flag (AF in register Control\_2) is set logic 1.

The generation of interrupts from the alarm function is controlled via bit AIE. If bit AIE is enabled, the INT pin follows the condition of bit AF. AF remains set until cleared by command. Once AF has been cleared, it will only be set again when the time increments to match the alarm condition once more. Alarm registers which have their AEN\_x bit at logic 1 are ignored.

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#### 8.6 Timer registers

The 8-bit countdown timer at address 10h is controlled by the register Timer\_mode at address 11h.

#### 8.6.1 Register Timer\_value

#### Table 34. Timer\_value - timer value register (address 10h) bit description

Bit	Symbol	Value	Description
7 to 0	T[7:0]	0h <u><sup>[1]</sup></u> to FFh	countdown timer value <sup>[2]</sup>

[1] Default value.

[2] Countdown period in seconds:  $CountdownPeriod = \frac{T}{SourceClockFrequency}$  where T is the countdown value.

#### 8.6.2 Register Timer\_mode

#### Table 35. Timer\_mode - timer control register (address 11h) bit description

Bit	Symbol	Value	Description
7 to 5	-	000	unused
4 to 3	TCF[1:0]		timer clock frequency
		00	4.096 kHz timer source clock
		01	64 Hz timer source clock
		10	1 Hz timer source clock
		11 <sup>[1]</sup>	1/ <sub>60</sub> Hz timer source clock
2	TE		timer enable
		0 <u>[1]</u>	timer is disabled
		1	timer is enabled
1	TIE		timer interrupt enable
		0 <u>[1]</u>	no interrupt generated from timer
		1	interrupt generated from timer
0	TI_TP <sup>[2]</sup>		timer interrupt mode
		0 <u>[1]</u>	interrupt follows timer flag
		1	interrupt generates a pulse

[1] Default value.

[2] How the setting of TI\_TP and the timer flag TF can affect the INT pulse generation is explained in <u>Section 8.2.2.3 on page 13</u>.

#### 8.6.3 Timer functions

The timer has four selectable source clocks allowing for countdown periods in the range from 244  $\mu s$  to 4 hours 15 min. For periods longer than 4 hours, the alarm function can be used.

TCF[1:0]	Timer source clock frequency <sup>[1]</sup>	Delay			
		Minimum timer duration T = 1	Maximum timer duration T = 255		
00	4.096 kHz	244 μs	62.256 ms		
01	64 Hz	15.625 ms	3.984 s		
10	1 Hz <sup>[2]</sup>	1 s	255 s		
11	<sup>1</sup> / <sub>60</sub> Hz <sup>[2]</sup>	60 s	4 hours 15 min		

 Table 36.
 Timer clock frequency and timer durations

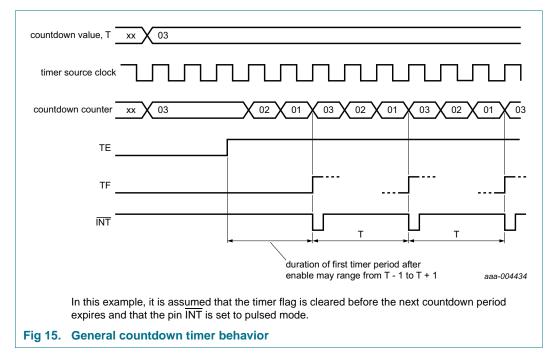
[1] When not in use, TCF[1:0] must be set to  $\frac{1}{60}$  Hz for power saving.

[2] Time periods can be affected by correction pulses.

**Remark:** Note that all timings which are generated from the 32.768 kHz oscillator are based on the assumption that there is 0 ppm deviation. Deviation in oscillator frequency results in deviation in timings. This is not applicable to interface timing.

The timer counts down from a software-loaded 8-bit binary value, T[7:0], in register Timer\_value. Loading the counter with 0 stops the timer. Values from 1 to 255 are valid.

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When the counter decrements from 1, the timer flag (bit TF in register Control\_2) is set and the counter automatically re-loads and starts the next timer period.

If a new value of T is written before the end of the current timer period, then this value takes immediate effect. NXP does not recommend changing T without first disabling the counter by setting bit TE logic 0. The update of T is asynchronous to the timer clock. Therefore changing it without setting bit TE logic 0 may result in a corrupted value loaded into the countdown counter. This results in an undetermined countdown period for the first period. The countdown value T will, however, be correctly stored and correctly loaded on subsequent timer periods.

When the TIE flag is set, an interrupt signal on  $\overline{INT}$  is generated if this mode is enabled. See <u>Section 8.2.2</u> for details on how the interrupt can be controlled.

When starting the timer for the first time, the first period has an uncertainty. The uncertainty is a result of the enable instruction being generated from the interface clock which is asynchronous from the timer source clock. Subsequent timer periods do not have such delay. The amount of delay for the first timer period depends on the chosen source clock, see Table 37.

Timer source clock	Minimum timer period	Maximum timer period
4.096 kHz	Т	T + 1
64 Hz	Т	T + 1
1 Hz	$(T-1) + \frac{1}{64} \text{ Hz}$	$T + \frac{l}{64 \text{ Hz}}$
1⁄ <sub>60</sub> Hz	$(T-1) + \frac{1}{64} \text{ Hz}$	$T + \frac{l}{64 \text{ Hz}}$

At the end of every countdown, the timer sets the countdown timer flag (bit TF in register Control 2). Bit TF can only be cleared by command. The asserted bit TF can be used to generate an interrupt at pin INT. The interrupt may be generated as a pulsed signal every countdown period or as a permanently active signal which follows the condition of bit TF. Bit TI TP is used to control this mode selection and the interrupt output may be disabled with bit TIE, see Table 35 and Figure 15.

When reading the timer, the current countdown value is returned and **not** the initial value T. Since it is not possible to freeze the countdown timer counter during read back, it is recommended to read the register twice and check for consistent results.

Timer source clock frequency selection of 1 Hz and  $\frac{1}{60}$  Hz is affected by the Offset register. The duration of a program period varies according to when the offset is initiated. For example, if a 100 s timer is set using the 1 Hz clock as source, then some 100 s periods will contain correction pulses and therefore be longer or shorter depending on the setting of the Offset register. See Section 8.2.3 to understand the operation of the Offset register.

#### **Countdown timer interrupts** 8.6.3.1

The pulse generator for the countdown timer interrupt uses an internal clock and is dependent on the selected source clock for the countdown timer and on the countdown value T. As a consequence, the width of the interrupt pulse varies (see Table 38).

Table	38.	INT	operation

IF and in Decome active	e sintulianeousiy.		
Source clock (Hz)	INT period (s)		
	T = 1 <sup>[1]</sup>	T > 1 <sup>[1]</sup>	
4096	<sup>1</sup> / <sub>8192</sub>	1/4096	
64	1/ <sub>128</sub>	1/64	
1	1/64	1/64	
1/60	1/64	1/64	

#### TE and INT become active simultaneously

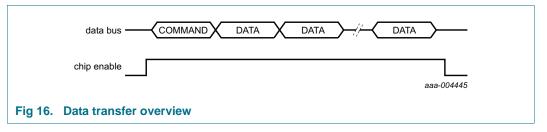
[1] T = loaded countdown value. Timer stops when T = 0.

## 9. Characteristics of the SPI-bus interface

Data transfer to and from the device is made via a 3-wire SPI-bus (see <u>Table 39</u>). The chip enable signal is used to identify the transmitted data. Each data transfer is a byte, with the Most Significant Bit (MSB) sent first (see Figure 16).

Table 39.	Serial interface			
Symbol	Function	Description		
CE	chip enable input	when LOW, the interface is reset; pull-down resistor included; active input may be higher than $V_{\text{DD}}$ , but may not be wired permanently HIGH		
SCL	serial clock input	when CE is LOW, this input may float; input may be higher than $V_{\text{DD}}$		
SDIO	serial data input and output			
	input	when CE is LOW, input may float; input may be higher than $V_{\text{DD}};$ input data is sampled on the rising edge of SCL		
	output	push-pull output; drives from $V_{\text{SS}}$ to $V_{\text{DD}}$ ; output data is changed on the falling edge of SCL; is high-impedance when not driving		

The transmission is controlled by the active HIGH chip enable signal CE. The first byte transmitted is the command byte. Subsequent bytes are either data to be written or data to be read. Data is sampled on the rising edge of the clock and transferred internally on the falling edge.



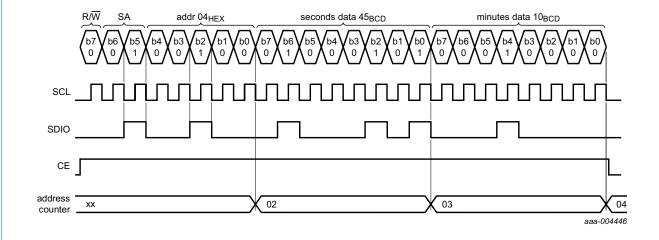
The command byte defines the address of the first register to be accessed and the read/write mode. The address counter will auto increment after every access and will roll over to zero after the last register is accessed (see Figure 3). The (R/W) bit defines whether the following bytes are read or write information.

Table 40.	Command by	te definition
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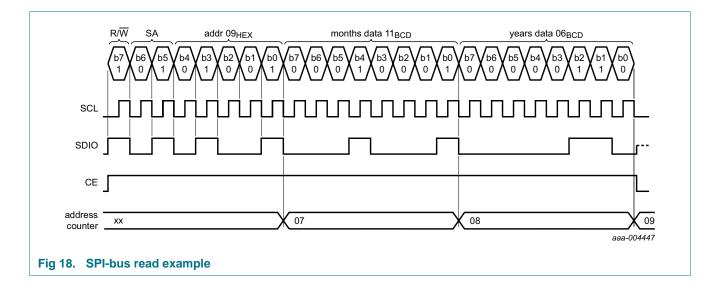
Bit	Symbol	Value	Description
7	R/W		data read or data write selection
		0	write data
		1	read data
6 to 5	SA	01	<b>subaddress</b> ; other codes will cause the device to ignore data transfer
4 to 0	RA	0h to 11h	register address range; other addresses will be ignored

In <u>Figure 17</u>, the register Seconds is set to 45 seconds and the register Minutes is set to 10 minutes. In Figure 18, the Months and Years registers are read.

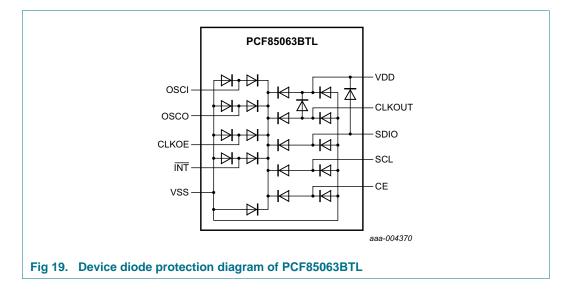
Tiny Real-Time Clock/calendar with alarm function and SPI-bus



#### Fig 17. SPI-bus write example



## **10. Internal circuitry**



## 11. Safety notes

# CAUTION

This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices.

Such precautions are described in the ANSI/ESD S20.20, IEC/ST 61340-5, JESD625-A or equivalent standards.

#### Tiny Real-Time Clock/calendar with alarm function and SPI-bus

## 12. Limiting values

#### Table 41.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>DD</sub>	supply voltage		-0.5	+6.5	V
I <sub>DD</sub>	supply current		-50	+50	mA
VI	input voltage	on pins SCL, SDIO, OSCI	-0.5	+6.5	V
Vo	output voltage		-0.5	+6.5	V
lı	input current	at any input	-10	+10	mA
lo	output current	at any output	-10	+10	mA
P <sub>tot</sub>	total power dissipation		-	300	mW
V <sub>ESD</sub>	electrostatic discharge	HBM [1]	-	±5000	V
	voltage	CDM [2]	-	±2000	V
l <sub>lu</sub>	latch-up current	[3]	-	200	mA
T <sub>stg</sub>	storage temperature	[4]	-65	+150	°C
T <sub>amb</sub>	ambient temperature	operating device	-40	+85	°C

[1] Pass level; Human Body Model (HBM) according to Ref. 7 "JESD22-A114".

[2] Pass level; Charged-Device Model (CDM), according to Ref. 8 "JESD22-C101".

[3] Pass level; latch-up testing, according to Ref. 9 "JESD78" at maximum ambient temperature (T<sub>amb(max)</sub>).

[4] According to the store and transport requirements (see <u>Ref. 13 "UM10569"</u>) the devices have to be stored at a temperature of +8 °C to +45 °C and a humidity of 25 % to 75 %.

# **13. Characteristics**

#### Table 42. Static characteristics

 $V_{DD} = 0.9 \text{ V}$  to 5.5 V;  $V_{SS} = 0 \text{ V}$ ;  $T_{amb} = -40 \text{ °C}$  to +85 °C;  $f_{osc} = 32.768 \text{ kHz}$ ; quartz  $R_s = 60 \text{ k}\Omega$ ;  $C_L = 7 \text{ pF}$ ; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Supplies		I	1	I		
V <sub>DD</sub>	supply voltage	interface inactive; [1] f <sub>SCL</sub> = 0 MHz	0.9	-	5.5	V
		interface active; [2] f <sub>SCL</sub> = 1 MHz	1.8	-	5.5	V
I <sub>DD</sub>	supply current	CLKOUT disabled; [3] $V_{DD} = 3.3 V$				
		interface inactive; f <sub>SCL</sub> = 0 Hz				
		T <sub>amb</sub> = 25 °C	-	220	450	nA
		$T_{amb} = 50 \ ^{\circ}C$	-	250	500	nA
		T <sub>amb</sub> = 85 °C	-	470	600	nA
		interface active; f <sub>SCL</sub> = 1 MHz	-	45	200	μA
Inputs <sup>[5]</sup>						
VI	input voltage		-0.5	-	+5.5	V
V <sub>IL</sub>	LOW-level input voltage		-0.5	-	+0.3V <sub>DD</sub>	V
V <sub>IH</sub>	HIGH-level input voltage		$0.7V_{DD}$	-	5.5	V
ILI	input leakage current	$V_I = V_{SS} \text{ or } V_{DD}$	-	0	-	μΑ
		post ESD event	-0.15	-	+0.15	μΑ
Ci	input capacitance	on pins SDIO, SCL, CE, 6 CLKOE	-	-	7	pF
Outputs				·		·
V <sub>OH</sub>	HIGH-level output voltage	on pins SDIO, CLKOUT	$0.8V_{DD}$	-	V <sub>DD</sub>	V
V <sub>OL</sub>	LOW-level output voltage	on pins SDIO, INT, CLKOUT	V <sub>SS</sub>	-	0.2V <sub>DD</sub>	V
I <sub>OH</sub>	HIGH-level output current	output source current; $V_{OH} = 2.9 V;$ $V_{DD} = 3.3 V$				
		on pin SDIO	2	5	-	mA
		on pin CLKOUT	1	3	-	mA
I <sub>OL</sub>	LOW-level output current	output sink current; $V_{OL} = 0.4 V$ ; $V_{DD} = 3.3 V$				
		on pins SDIO, INT	2	6	-	mA
		on pin CLKOUT	1	3	-	mA

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#### Table 42. Static characteristics ...continued

 $V_{DD} = 0.9 \text{ V}$  to 5.5 V;  $V_{SS} = 0 \text{ V}$ ;  $T_{amb} = -40 \text{ °C}$  to +85 °C;  $f_{osc} = 32.768 \text{ kHz}$ ; quartz  $R_s = 60 \text{ k}\Omega$ ;  $C_L = 7 \text{ pF}$ ; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Oscillator						
$\Delta f_{osc}/f_{osc}$	relative oscillator frequency variation	$\Delta V_{DD}$ = 200 mV; T <sub>amb</sub> = 25 °C	-	0.075	-	ppm
C <sub>L(itg)</sub>	integrated load capacitance	on pins OSCO, OSCI				
		C <sub>L</sub> = 7 pF	4.2	7	9.8	pF
		C <sub>L</sub> = 12.5 pF	7.5	12.5	17.5	pF
R <sub>s</sub>	series resistance		-	-	100	kΩ

[1] For reliable oscillator start-up at power-on use V<sub>DD</sub> greater than 1.2 V. If powered up at 0.9 V the oscillator will start but it might be a bit slow, especially if at high temperature. Normally the power supply is not 0.9 V at start-up and only comes at the end of battery discharge. V<sub>DD</sub> min of 0.9 V is specified so that the customer can calculate how large a battery or capacitor they need for their application. V<sub>DD</sub> min of 1.2 V or greater is needed to ensure speedy oscillator start-up time.

[2] 400 kHz I2C operation is production tested at 1.8 V. Design methodology allows I2C operation at 1.8 V – 5 % (1.71 V) which has been verified during product characterization on a limited number of devices.

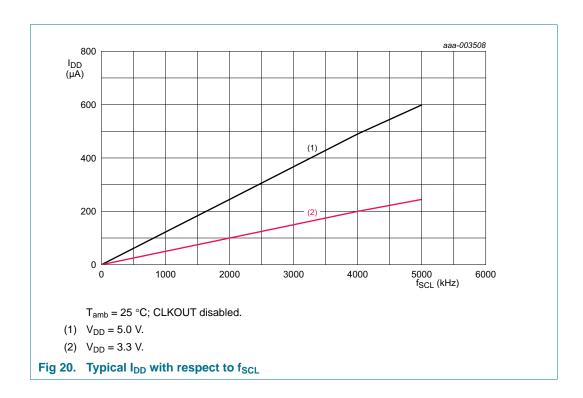
[3] Timer source clock =  $\frac{1}{60}$  Hz, level of pins CE, SDIO, and SCL is V<sub>DD</sub> or V<sub>SS</sub>.

[4] Tested on sample basis.

[5] The SPI interface of PCF85063BTL is 5 V tolerant.

[6] Implicit by design.

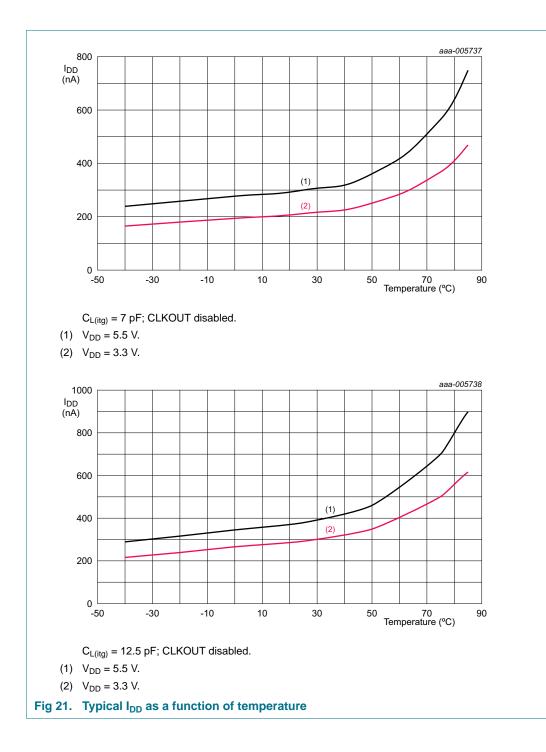
[7] Integrated load capacitance,  $C_{L(itg)}$ , is a calculation of  $C_{OSCI}$  and  $C_{OSCO}$  in series:  $C_{L(itg)} = \frac{(C_{OSCI} \cdot C_{OSCO})}{(C_{OSCI} + C_{OSCO})}$ .



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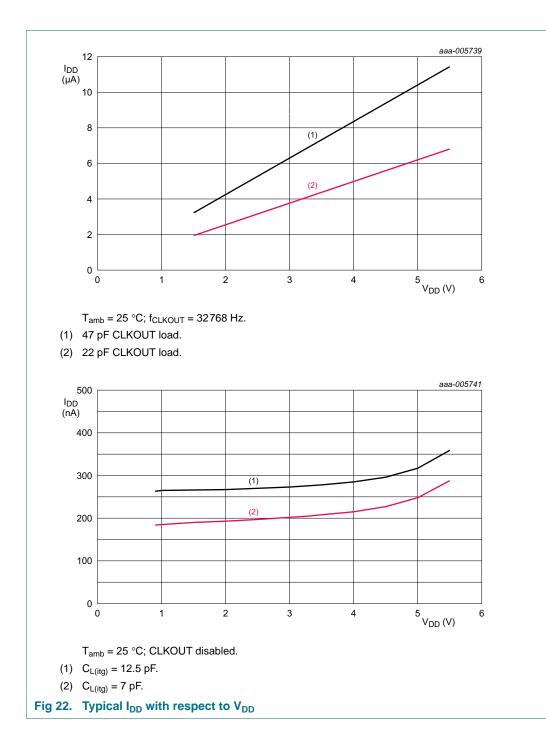
# PCF85063BTL

#### Tiny Real-Time Clock/calendar with alarm function and SPI-bus



# **PCF85063BTL**

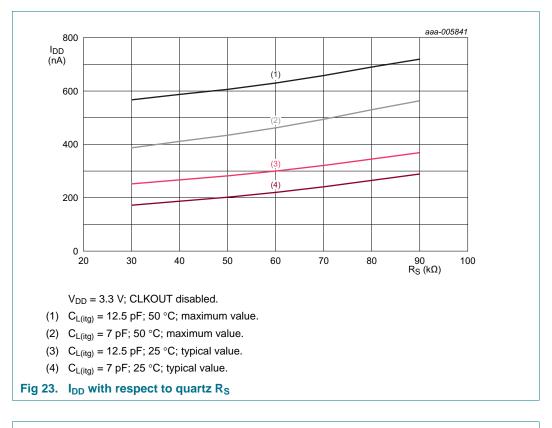
#### Tiny Real-Time Clock/calendar with alarm function and SPI-bus

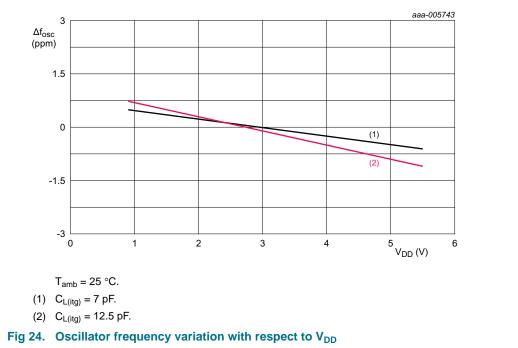


PCF85063BTL **Product data sheet** 

# PCF85063BTL

#### Tiny Real-Time Clock/calendar with alarm function and SPI-bus





#### Tiny Real-Time Clock/calendar with alarm function and SPI-bus

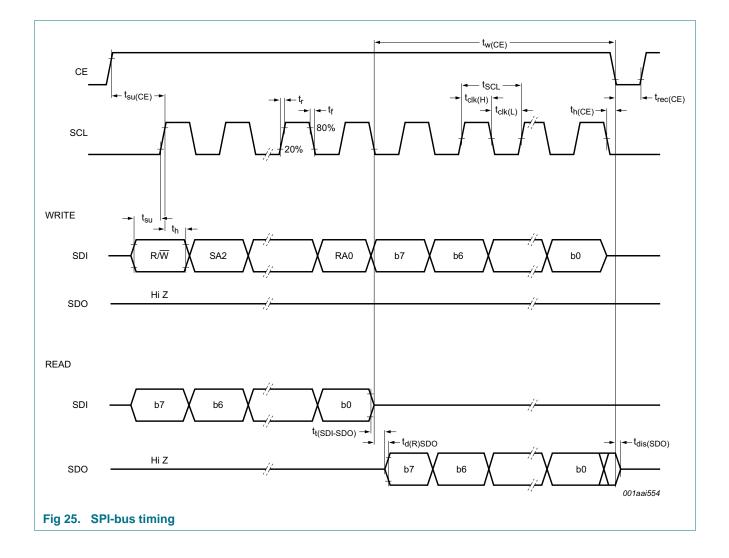
#### Table 43. SPI-bus characteristics

 $V_{DD} = 1.8 \text{ V}$  to 5.5 V;  $V_{SS} = 0 \text{ V}$ ;  $T_{amb} = -40 \text{ °C}$  to +85 °C;  $f_{osc} = 32.768 \text{ kHz}$ ; quartz  $R_s = 60 \text{ k}\Omega$ ;  $C_L = 7 \text{ pF}$ ; unless otherwise specified. All timing values are valid within the operating supply voltage and temperature range and referenced to  $V_{IL}$  and  $V_{IH}$  with an input voltage swing of  $V_{SS}$  to  $V_{DD}$ .

Symbol	Parameter	Conditions	$V_{DD} = 1$	.8 V to 3.3 V	$V_{DD} > 3$	.3 V to 5.5 V	Unit
			Min	Max	Min	Max	1
f <sub>SCL</sub>	SCL clock frequency		-	5	-	7	MHz
t <sub>SCL</sub>	SCL time		200	-	140	-	ns
t <sub>clk(H)</sub>	clock HIGH time		80	-	80	-	ns
t <sub>clk(L)</sub>	clock LOW time		110	-	60	-	ns
t <sub>r</sub>	rise time	for SCL signal	-	100	-	100	ns
t <sub>f</sub>	fall time	for SCL signal	-	100	-	100	ns
t <sub>su(CE)</sub>	CE set-up time		15	-	15	-	ns
t <sub>h(CE)</sub>	CE hold time		10	-	10	-	ns
t <sub>rec(CE)</sub>	CE recovery time		50	-	50	-	ns
t <sub>w(CE)</sub>	CE pulse width	measured after valid subaddress is received	-	0.99	-	0.99	S
t <sub>su</sub>	set-up time	set-up time for SDIO data	5	-	5	-	ns
t <sub>h</sub>	hold time	hold time for SDIO data	50	-	20	-	ns
t <sub>d(R)SDO</sub>	SDO read delay time	bus load = 50 pF	-	110	-	60	ns
t <sub>dis(SDO)</sub>	SDO disable time	no load value; bus will be held up by bus capacitance; use RC time constant with application values	-	50	-	50	ns
$t_{t(SDI-SDO)}$	transition time from SDI to SDO	to avoid bus conflict; on pin SDIO	0	-	0	-	ns

# PCF85063BTL

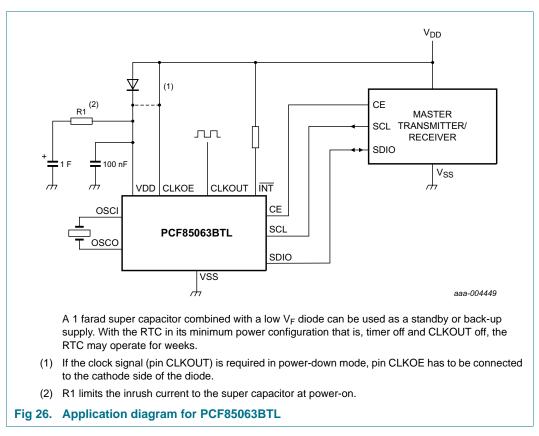
#### Tiny Real-Time Clock/calendar with alarm function and SPI-bus



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#### Tiny Real-Time Clock/calendar with alarm function and SPI-bus

## 14. Application information

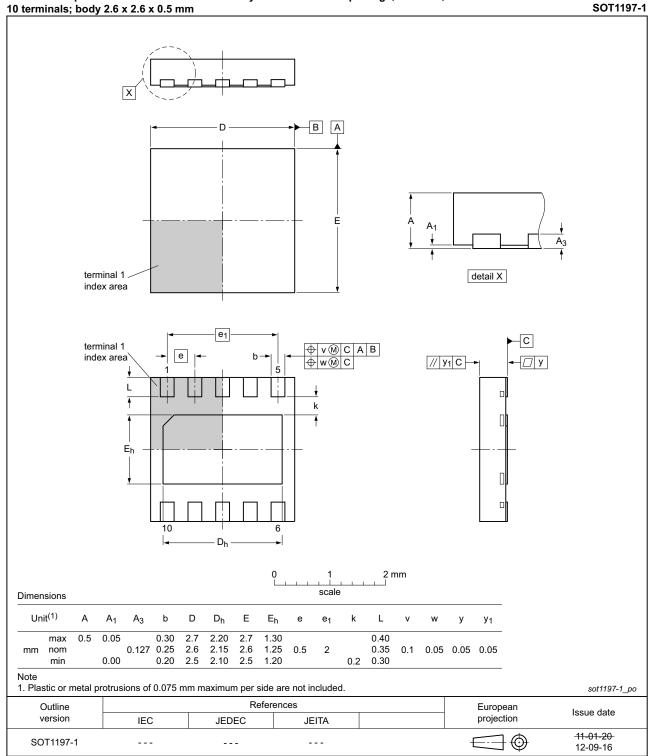


The data sheet values were obtained using a crystal with an ESR of 60 k $\Omega$ . If a crystal with an ESR of 70 k $\Omega$  is used then the power consumption would increase by a few nA and the start-up time will increase slightly.

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Tiny Real-Time Clock/calendar with alarm function and SPI-bus

## 15. Package outline



DFN2626-10: plastic thermal enhanced extremely thin small outline package; no leads;

Fig 27. Package outline SOT1197-1 (DFN2626-10) of PCF85063BTL

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#### Tiny Real-Time Clock/calendar with alarm function and SPI-bus

## **16. Handling information**

All input and output pins are protected against ElectroStatic Discharge (ESD) under normal handling. When handling Metal-Oxide Semiconductor (MOS) devices ensure that all normal precautions are taken as described in JESD625-A, IEC 61340-5 or equivalent standards.

## 17. Packing information

## 17.1 Tape and reel information

For tape and reel packing information, see Ref. 11 "SOT1197-1\_115".

## **18. Soldering of SMD packages**

This text provides a very brief insight into a complex technology. A more in-depth account of soldering ICs can be found in Application Note *AN10365 "Surface mount reflow soldering description"*.

## 18.1 Introduction to soldering

Soldering is one of the most common methods through which packages are attached to Printed Circuit Boards (PCBs), to form electrical circuits. The soldered joint provides both the mechanical and the electrical connection. There is no single soldering method that is ideal for all IC packages. Wave soldering is often preferred when through-hole and Surface Mount Devices (SMDs) are mixed on one printed wiring board; however, it is not suitable for fine pitch SMDs. Reflow soldering is ideal for the small pitches and high densities that come with increased miniaturization.

## 18.2 Wave and reflow soldering

Wave soldering is a joining technology in which the joints are made by solder coming from a standing wave of liquid solder. The wave soldering process is suitable for the following:

- Through-hole components
- Leaded or leadless SMDs, which are glued to the surface of the printed circuit board

Not all SMDs can be wave soldered. Packages with solder balls, and some leadless packages which have solder lands underneath the body, cannot be wave soldered. Also, leaded SMDs with leads having a pitch smaller than ~0.6 mm cannot be wave soldered, due to an increased probability of bridging.

The reflow soldering process involves applying solder paste to a board, followed by component placement and exposure to a temperature profile. Leaded packages, packages with solder balls, and leadless packages are all reflow solderable.

Key characteristics in both wave and reflow soldering are:

- · Board specifications, including the board finish, solder masks and vias
- · Package footprints, including solder thieves and orientation
- · The moisture sensitivity level of the packages
- Package placement
- Inspection and repair
- Lead-free soldering versus SnPb soldering

## 18.3 Wave soldering

Key characteristics in wave soldering are:

- Process issues, such as application of adhesive and flux, clinching of leads, board transport, the solder wave parameters, and the time during which components are exposed to the wave
- Solder bath specifications, including temperature and impurities

## 18.4 Reflow soldering

Key characteristics in reflow soldering are:

- Lead-free versus SnPb soldering; note that a lead-free reflow process usually leads to higher minimum peak temperatures (see <u>Figure 28</u>) than a SnPb process, thus reducing the process window
- Solder paste printing issues including smearing, release, and adjusting the process window for a mix of large and small components on one board
- Reflow temperature profile; this profile includes preheat, reflow (in which the board is heated to the peak temperature) and cooling down. It is imperative that the peak temperature is high enough for the solder to make reliable solder joints (a solder paste characteristic). In addition, the peak temperature must be low enough that the packages and/or boards are not damaged. The peak temperature of the package depends on package thickness and volume and is classified in accordance with Table 44 and 45

#### Table 44. SnPb eutectic process (from J-STD-020D)

Package thickness (mm)	Package reflow temperature (°C)			
	Volume (mm <sup>3</sup> )			
	< 350	≥ 350		
< 2.5	235	220		
≥ 2.5	220	220		

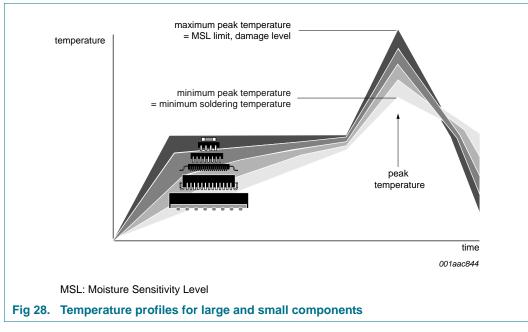
#### Table 45. Lead-free process (from J-STD-020D)

Package thickness (mm)	Package reflow temperature (°C)					
	Volume (mm <sup>3</sup> )					
	< 350	350 to 2000	> 2000			
< 1.6	260	260	260			
1.6 to 2.5	260	250	245			
> 2.5	250	245	245			

Moisture sensitivity precautions, as indicated on the packing, must be respected at all times.

Studies have shown that small packages reach higher temperatures during reflow soldering, see Figure 28.

Tiny Real-Time Clock/calendar with alarm function and SPI-bus

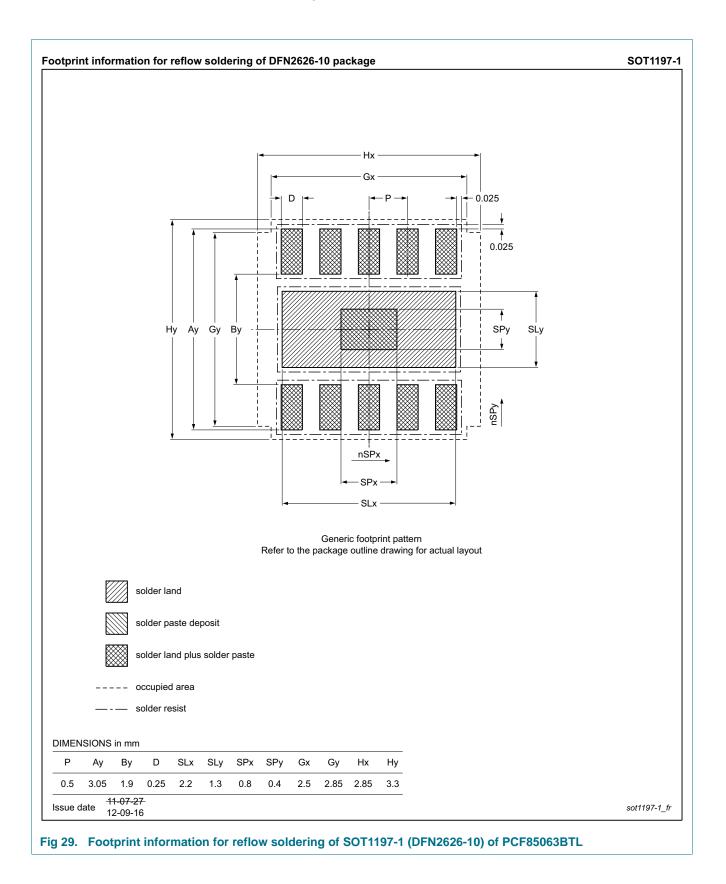


For further information on temperature profiles, refer to Application Note *AN10365 "Surface mount reflow soldering description"*.

## **19. Footprint information**

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## 20. Appendix

## 20.1 Real-Time Clock selection

#### Table 46. Selection of Real-Time Clocks

Type name	Alarm, Timer, Watchdog	Interrupt output	Interface	I <sub>DD</sub> , typical (nA)	Battery backup	Timestamp, tamper input	AEC-Q100 compliant	Special features	Packages
PCF85063TP	-	1	I <sup>2</sup> C	220	-	-	-	basic functions only, no alarm	HXSON8
PCF85063A	X	1	I <sup>2</sup> C	220	-	-	-	tiny package	SO8, DFN2626-10, TSSOP8
PCF85063B	Х	1	SPI	220	-	-	-	tiny package	DFN2626-10
PCF85263A	X	2	I <sup>2</sup> C	230	X	X	-	time stamp, battery backup, stopwatch ¼ <sub>100</sub> s	SO8, TSSOP10, TSSOP8, DFN2626-10
PCF85263B	Х	2	SPI	230	Х	X	-	time stamp, battery backup, stopwatch <sup>1</sup> / <sub>100</sub> s	TSSOP10, DFN2626-10
PCF85363A	X	2	I <sup>2</sup> C	230	X	X	-	time stamp, battery backup, stopwatch ¼ <sub>100</sub> s, 64 Byte RAM	TSSOP10, TSSOP8, DFN2626-10
PCF85363B	X	2	SPI	230	X	Х	-	time stamp, battery backup, stopwatch ¼ <sub>100</sub> s, 64 Byte RAM	TSSOP10, DFN2626-10
PCF2123	X	1	SPI	100	-	-	-	lowest power 100 nA in operation	TSSOP14, HVQFN16
PCF8523	X	2	I <sup>2</sup> C	150	Х	-	-	lowest power 150 nA in operation, FM+ 1 MHz	SO8, HVSON8, TSSOP14, WLCSP
PCF8563	X	1	I <sup>2</sup> C	250	-	-	-	-	SO8, TSSOP8, HVSON10
PCA8565	X	1	I <sup>2</sup> C	600	-	-	grade 1	high robustness, T <sub>amb</sub> = -40 °C to 125 °C	TSSOP8, HVSON10
PCA8565A	X	1	I <sup>2</sup> C	600	-	-	-	integrated oscillator caps, T <sub>amb</sub> = -40 °C to 125 °C	WLCSP
PCF8564A	Х	1	I <sup>2</sup> C	250	-	-	-	integrated oscillator caps	WLCSP

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Гуре name	Alarm, Timer, Watchdog	Interrupt output	Interface	I <sub>DD</sub> , typical (nA)	Battery backup	Timestamp, tamper input	AEC-Q100 compliant	Special features	Packages
PCF2127	x	1	I <sup>2</sup> C and SPI	500	X	X	-	temperature compensated, quartz built in, calibrated, 512 Byte RAM	SO16
PCF2127A	X	1	I <sup>2</sup> C and SPI	500	X	X	-	temperature compensated, quartz built in, calibrated, 512 Byte RAM	SO20
PCF2129	X	1	I <sup>2</sup> C and SPI	500	Х	X	-	temperature compensated, quartz built in, calibrated	SO16
PCF2129A	X	1	I <sup>2</sup> C and SPI	500	X	X	-	temperature compensated, quartz built in, calibrated	SO20
PCA2129	X	1	I <sup>2</sup> C and SPI	500	X	Х	grade 3	temperature compensated, quartz built in, calibrated	SO16
PCA21125	Х	1	SPI	820	-	-	grade 1	high robustness, T <sub>amb</sub> = -40 °C to 125 °C	TSSOP14

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Tiny Real-Time Clock/calendar with alarm function and SPI-bus

## 21. Abbreviations

Table 47. Abbreviations					
Acronym	Description				
AM	Ante Meridiem				
BCD	Binary Coded Decimal				
CDM	Charged-Device Model				
CMOS	Complementary Metal Oxide Semiconductor				
ESD	ElectroStatic Discharge				
НВМ	Human Body Model				
IC	Integrated Circuit				
LSB	Least Significant Bit				
MSB	Most Significant Bit				
MSL	Moisture Sensitivity Level				
PCB	Printed-Circuit Board				
PM	Post Meridiem				
POR	Power-On Reset				
RAM	Random Access Memory				
RTC	Real-Time Clock				
SMD	Surface Mount Device				
SPI	Serial Peripheral Interface				

## 22. References

- [1] AN10365 Surface mount reflow soldering description
- [2] AN10366 HVQFN application information
- [3] AN11247 Improved timekeeping accuracy with PCF85063, PCF8523 and PCF2123 using an external temperature sensor
- [4] IEC 60134 Rating systems for electronic tubes and valves and analogous semiconductor devices
- [5] **IEC 61340-5** Protection of electronic devices from electrostatic phenomena
- [6] IPC/JEDEC J-STD-020 Moisture/Reflow Sensitivity Classification for Nonhermetic Solid State Surface Mount Devices
- [7] JESD22-A114 Electrostatic Discharge (ESD) Sensitivity Testing Human Body Model (HBM)
- [8] JESD22-C101 Field-Induced Charged-Device Model Test Method for Electrostatic-Discharge-Withstand Thresholds of Microelectronic Components
- [9] JESD78 IC Latch-Up Test
- [10] JESD625-A Requirements for Handling Electrostatic-Discharge-Sensitive (ESDS) Devices
- [11] SOT1197-1\_115 DFN2626-10; Reel pack; SMD, 7", packing information
- [12] UM10301 User Manual for NXP Real Time Clocks PCF85x3, PCA8565 and PCF2123, PCA2125
- [13] UM10569 Store and transport requirements
- [14] UM10699 User manual for SPI-bus RTC demoboard OM11059

PCF85063BTL

## 23. Revision history

Table 48.	Revision	history
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Document ID	Release date	Data sheet status	Change notice	Supersedes			
PCF85063BTL v.6	20151118	Product data sheet	-	PCF85063BTL v.5			
Modifications:	Updated Table 4 "Pin description" Table note 1						
	<ul> <li>Adjusted <u>Sec</u></li> </ul>	tion 8.2.2.4 paragraph 2					
	<ul> <li>Updated <u>Tab</u></li> </ul>	le 11 "CLKOUT frequency sele	ection" Table note 2				
	Table 42 "Sta	tic characteristics":					
	<ul> <li>Corrected</li> </ul>	$V_{\rm I}$ min from $V_{\rm SS}$ to –0.5 V					
	<ul> <li>Corrected</li> </ul>	$V_{\text{IL}}$ min from $V_{\text{SS}}$ to –0.5 V					
	– Corrected $V_{IH}$ max from $V_{DD}$ to 5.5 V						
	– Corrected <u>Table note 1</u>						
	<ul> <li>Added <u>Table note 2</u>, <u>Table note 5</u></li> </ul>						
	<ul> <li>Added text to</li> </ul>	Section 14 "Application inform	mation"				
PCF85063BTL v.5	20150506	Product data sheet	-	PCF85063BTL v.4			
Modifications:	<ul> <li>The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors.</li> </ul>						
	<ul> <li>Legal texts have been adapted to the new company name where appropriate.</li> </ul>						
	<ul> <li>Fixed typos</li> </ul>						
	Adjusted Section 8.2.2.2						
	<ul> <li>Updated package description (HXSON10 to DFN2626-10)</li> </ul>						
	Updated <u>Section 17.1</u>						
	<ul> <li>Added Section</li> </ul>	on 20.1					
PCF85063BTL v.4	20130712	Product data sheet	-	PCF85063BTL v.3			
PCF85063BTL v.3	20130502	Product data sheet	-	PCF85063BTL v.2			
PCF85063BTL v.2	20130415	Product data sheet	-	PCF85063BTL v.1			
PCF85063BTL v.1	20130123	Objective data sheet	-	-			

## 24. Legal information

## 24.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <a href="http://www.nxp.com">http://www.nxp.com</a>.

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